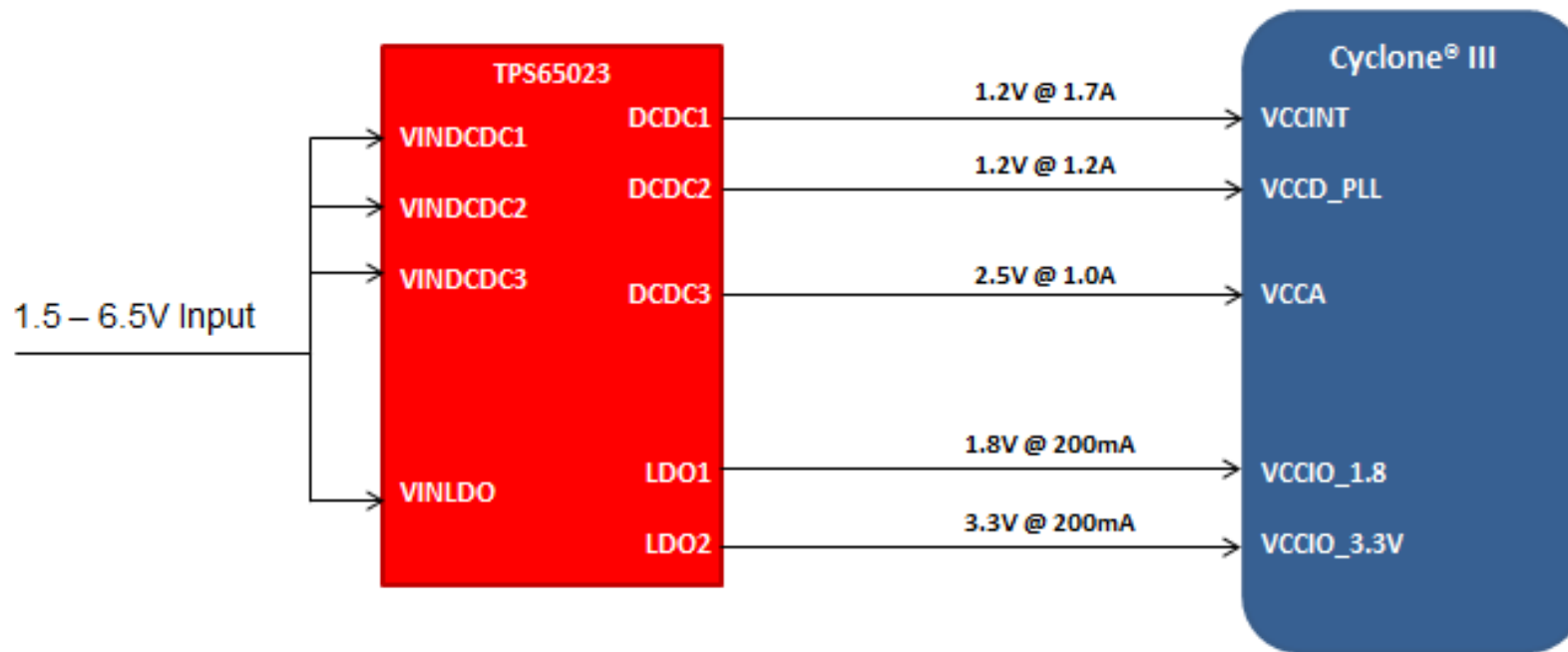
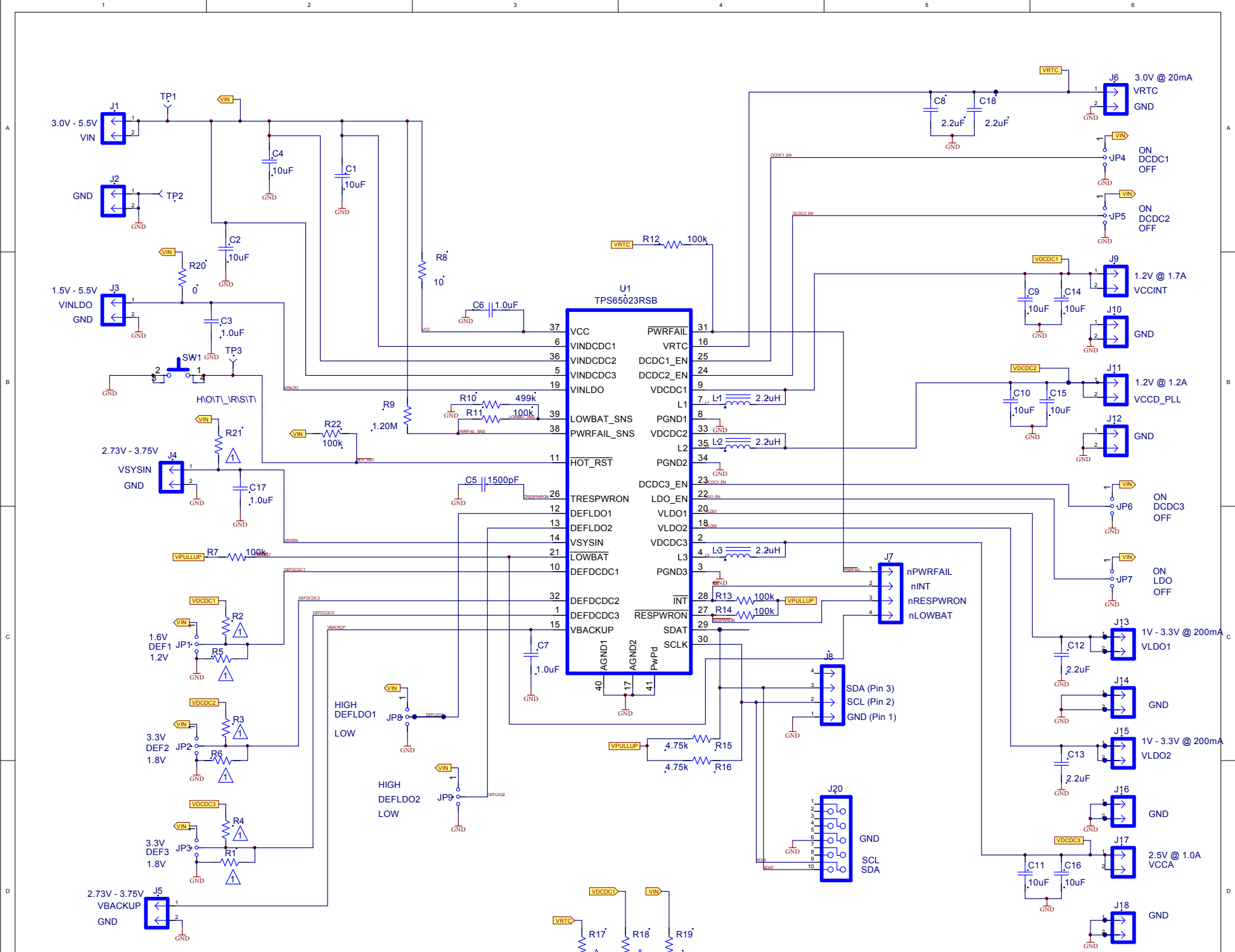


Revision History

Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A

### Altera® Cyclone® III TPS65023 Block Diagram





See BOM

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Orderable: N/A	Designed for: Public Release	Mod. Date: 6/18/2015	
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SVN Rev: Version control disabled	File: TIDA-0604_SchDoc	Size: B	http://www.ti.com
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